

DESIGN AND CONSTRUCTION OF THE ENDCAP TIMING LAYER Ian Reed on behalf of the CMS Collaboration Boston University

Motivation

- The High Luminosity LHC will drastically increase the number of interactions per bunch crossing
- -From $40 \rightarrow 200$ interactions
- Use timing to increase vertex resolution for interactions that overlap in space, but not time
- By using a precision of 30-50ps per track



MIP Timing Detector

- Installed between the tracker and the calorimeter, providing coverage up to $|\eta| < 3$
- Distinct radiation fluence at 3000fb^{-1}
- -Barrel: $1.7 \times 10^{14} n_{eq}/cm^2$ -Endcap: $1.5 \times 10^{15} n_{eq}/cm^2$



we expect to be able to maintain Run2 physics performance



ETL Structure

- Radius: 315mm < r < 1200mm
- z-position: $\pm 3m$, 99mm thick
- Two discs per endcap with modules covering both sides of the discs \rightarrow expect ≈ 2 hits per track
- $\bullet \approx 8000$ modules total across both endcaps, ≈ 8 million total channels



- Low Gain Avalanche Detectors (LGADs)
- Good radiation hardness
- Relatively thin sensor
- Low gain \rightarrow low noise, fast rising pulse
- Resolution of ≈ 30 ps for a charge deposit between $15-35\mathrm{fC}$
- Maintain performance after irradiation, up to 40ps resolution at 10fC under end of life conditions

Beamspot!!

TROC2 HPK BOTTOM BOARD HV210V Heat Map In

Sensors



Per hit resolution

Readout

Modules

• Each module will be made up of 4 LGADs, bump



- Low gain from LGADs \rightarrow low charge from sensors
- Readout contribution to time resolution has to be under 40ps
- Low power budget of 1W per chip \rightarrow need custom low power ASIC

ETROC2

- Prototype: 16x16 pixels with full functionality, expected performance demonstrated
- ETROC2 + 2x2LGAD testbeams recently completed
- Testing with 16x16 LGADs ongoing



Beamspot image from 16x16 LGAD testing

- bonded to 4 ETROCs
- Thermal interface provided by and AlN base plate
- Electrons provided by module PCB
- Assembly will occur at several sites, throughput testing recently completed



Front End Electronics

- Readout board based on CERN's radiation hard GBT chip-set and Optical Link Module, VTRx+
- Custom power board designed by Fermilab



Test System

- Running hardware integration tests of all components
- Demonstrated full readout chain up to the DAQ with bare ETROC2
- Preparing for testbeam using a fully setup sys-

Test Results





₽́T_EX TikZ**poster**



TDR

CMS Collaboration "A MIP Timing Detector for the CMS Phase-2 Upgrade." CERN-LHCC-2019-003

tem with bump bonded LGADs

• Will be used to module testing by assembly sites

